

Static Characteristics

 $T_J = 25^\circ\text{C}$ unless otherwise specified

APT34F100B2_L

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{BR(DSS)}$	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	1000			V
$\Delta V_{BR(DSS)}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	Reference to $25^\circ\text{C}, I_D = 250\mu\text{A}$		1.15		$\text{V}/^\circ\text{C}$
$R_{DS(on)}$	Drain-Source On Resistance ^③	$V_{GS} = 10V, I_D = 18\text{A}$		0.32	0.38	Ω
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 2.5\text{mA}$	2.5	4	5	V
$\Delta V_{GS(th)}/\Delta T_J$	Threshold Voltage Temperature Coefficient			-10		$\text{mV}/^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 1000\text{V}$	$T_J = 25^\circ\text{C}$		250	μA
		$V_{GS} = 0V$	$T_J = 125^\circ\text{C}$		1000	
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 30\text{V}$			± 100	nA

Dynamic Characteristics

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Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
g_{fs}	Forward Transconductance	$V_{DS} = 50\text{V}, I_D = 18\text{A}$		39		S
C_{iss}	Input Capacitance	$V_{GS} = 0V, V_{DS} = 25\text{V}$ $f = 1\text{MHz}$		9835		pF
C_{rss}	Reverse Transfer Capacitance			130		
C_{oss}	Output Capacitance			825		
$C_{o(cr)}^{\text{④}}$	Effective Output Capacitance, Charge Related	$V_{GS} = 0V, V_{DS} = 0\text{V to } 667\text{V}$		335		pF
$C_{o(er)}^{\text{⑤}}$	Effective Output Capacitance, Energy Related			170		
Q_g	Total Gate Charge	$V_{GS} = 0\text{ to } 10\text{V}, I_D = 18\text{A},$ $V_{DS} = 500\text{V}$		305		nC
Q_{gs}	Gate-Source Charge			55		
Q_{gd}	Gate-Drain Charge			145		
$t_{d(on)}$	Turn-On Delay Time	$\text{Resistive Switching}$ $V_{DD} = 667\text{V}, I_D = 18\text{A}$ $R_G = 2.2\Omega^{\text{⑥}}$, $V_{GG} = 15\text{V}$		39		ns
t_r	Current Rise Time			40		
$t_{d(off)}$	Turn-Off Delay Time			150		
t_f	Current Fall Time			38		

Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_s	Continuous Source Current (Body Diode)	MOSFET symbol showing the integral reverse p-n junction diode (body diode)			35	A
I_{SM}	Pulsed Source Current (Body Diode) ^①				140	
V_{SD}	Diode Forward Voltage	$I_{SD} = 18\text{A}, T_J = 25^\circ\text{C}, V_{GS} = 0\text{V}$			1.2	V
t_{rr}	Reverse Recovery Time	$I_{SD} = 18\text{A}^{\text{③}}$ $V_{DD} = 100\text{V}$ $di_{SD}/dt = 100\text{A}/\mu\text{s}$	$T_J = 25^\circ\text{C}$		300	ns
Q_{rr}	Reverse Recovery Charge		$T_J = 125^\circ\text{C}$		650	
I_{rrm}	Reverse Recovery Current		$T_J = 25^\circ\text{C}$	1.61		μC
I_{rrm}	Reverse Recovery Current		$T_J = 125^\circ\text{C}$	4.21		
dv/dt	Peak Recovery dv/dt	$I_{SD} \leq 18\text{A}, di/dt \leq 1000\text{A}/\mu\text{s}, V_{DD} = 667\text{V}, T_J = 125^\circ\text{C}$	$T_J = 25^\circ\text{C}$	11.6		A
dv/dt	Peak Recovery dv/dt		$T_J = 125^\circ\text{C}$	15.8		

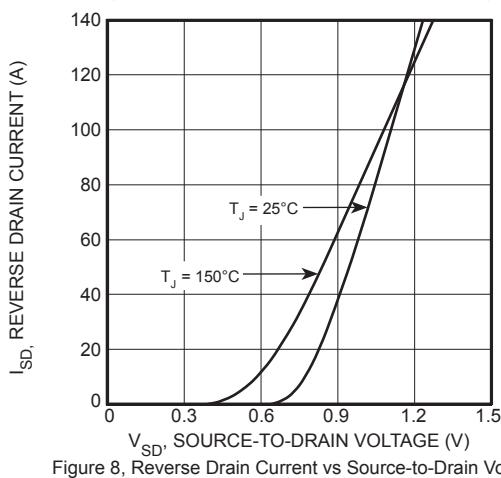
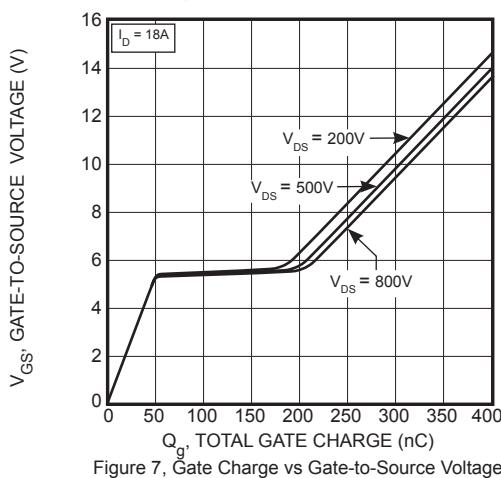
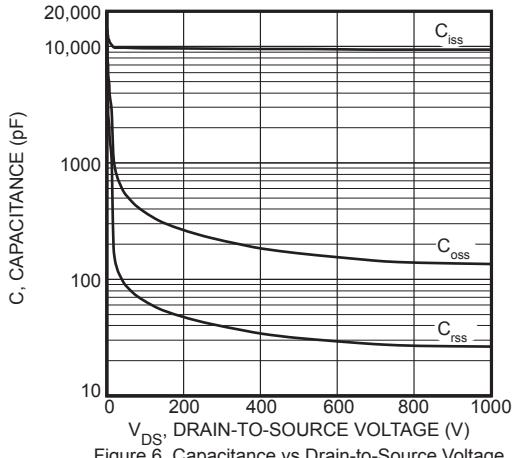
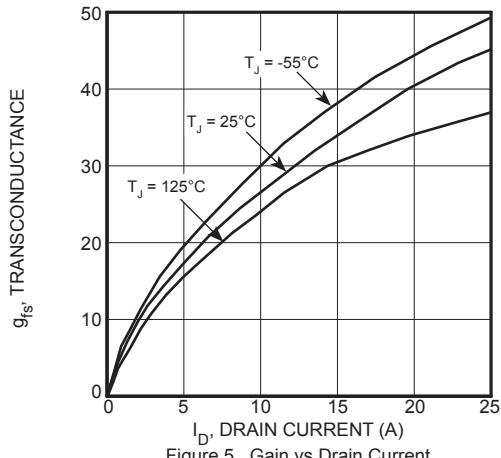
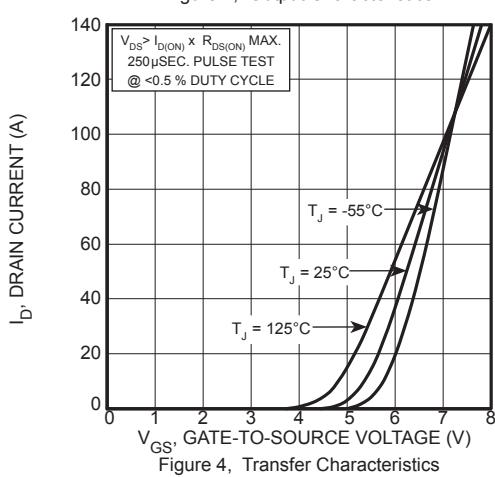
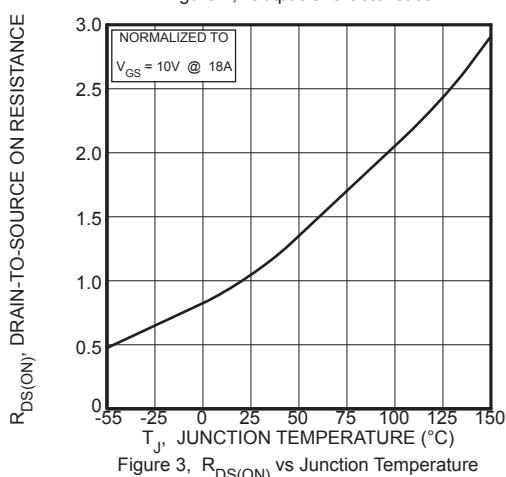
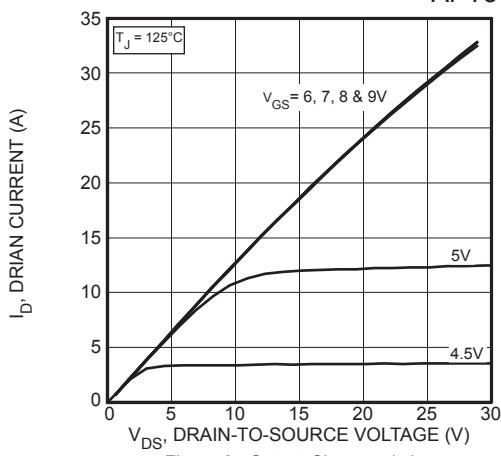
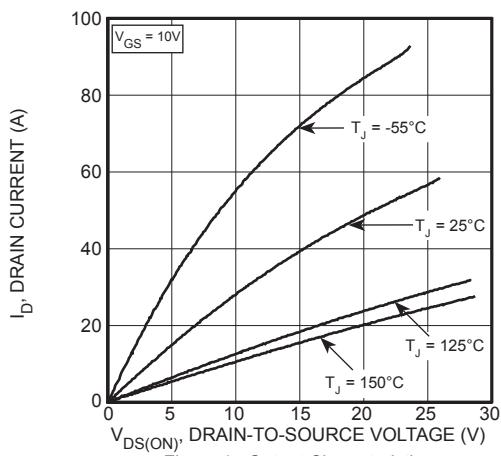
① Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

② Starting at $T_J = 25^\circ\text{C}$, $L = 13.36\text{mH}$, $R_G = 25\Omega$, $I_{AS} = 18\text{A}$.

③ Pulse test: Pulse Width < 380μs, duty cycle < 2%.

④ $C_{o(cr)}$ is defined as a fixed capacitance with the same stored charge as C_{oss} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$.⑤ $C_{o(er)}$ is defined as a fixed capacitance with the same stored energy as C_{oss} with $V_{DS} = 67\%$ of $V_{(BR)DSS}$. To calculate $C_{o(er)}$ for any value of V_{DS} less than $V_{(BR)DSS}$, use this equation: $C_{o(er)} = -2.85E-7/V_{DS}^2 + 5.04E-8/V_{DS} + 9.75E-11$.⑥ R_G is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



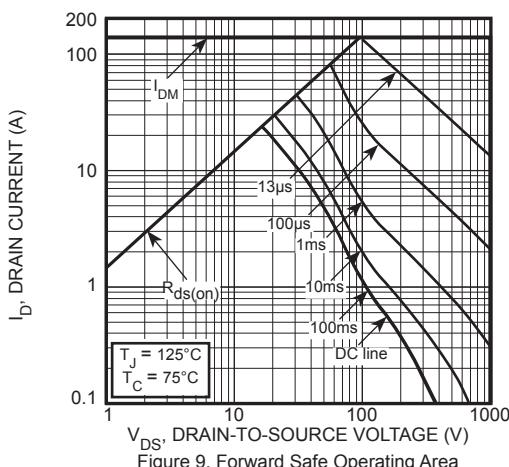


Figure 9, Forward Safe Operating Area

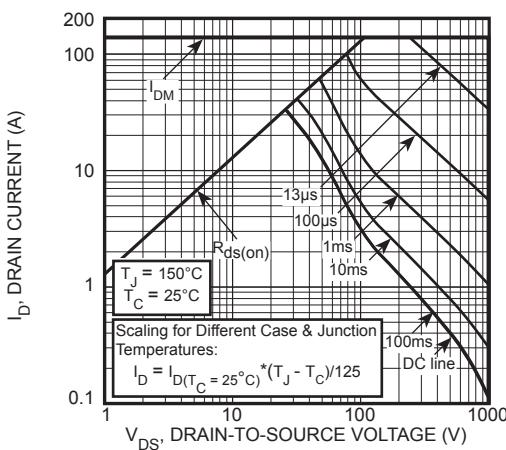


Figure 10, Maximum Forward Safe Operating Area

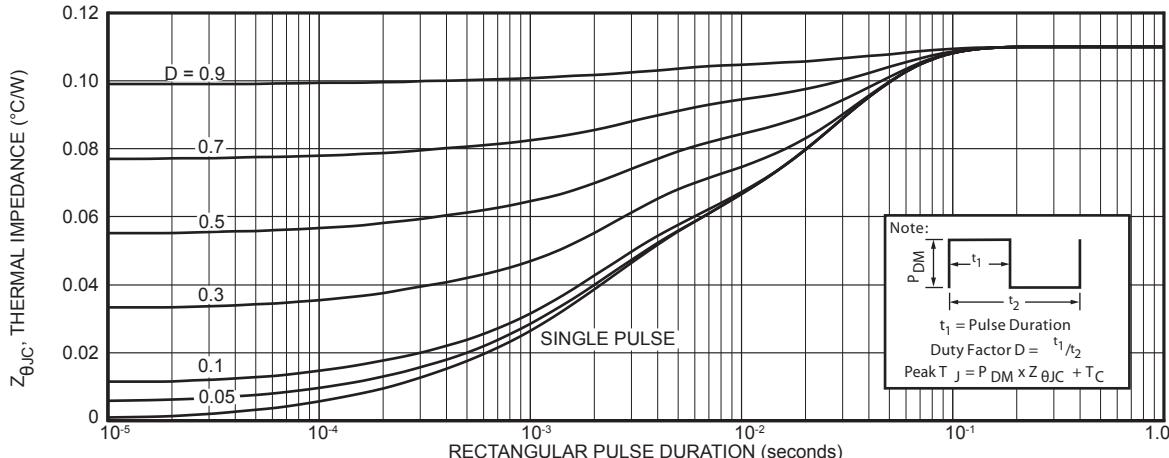
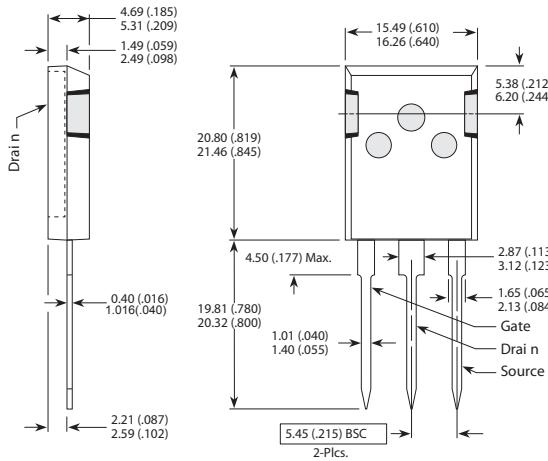


Figure 11. Maximum Effective Transient Thermal Impedance Junction-to-Case vs Pulse Duration

T-MAX® (B2) Package Outline

e3 100% Sn Plated



These dimensions are equal to the TO-247 without the mounting hole.
Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline